

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Gurtej S. Sandhu

Serial No.: 09/023,146

Filed: February 12, 1998

For: TUNGSTEN SILICIDE (WSIX)
DEPOSITION PROCESS FOR
SEMICONDUCTOR MANUFACTURE

Confirmation No.: 6553

Examiner: W. Coleman

Group Art Unit: 2823

Attorney Docket No.: 2269-3369.1US
(91-365RE)

VIA ELECTRONIC FILING
June 25, 2007

**FEE ADDRESSEE FOR RECEIPT OF PTO NOTICES
RELATING TO MAINTENANCE FEES**

Mail Stop ISSUE FEE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

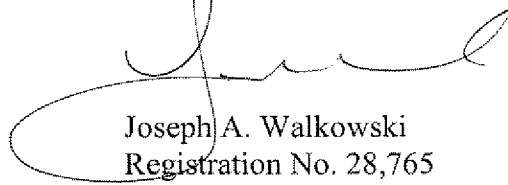
1. This letter is to specify that the FEE ADDRESSEE for this patent is:

MICRON TECHNOLOGY, INC.
Mail Stop 525
8000 South Federal Way
Boise, Idaho 83707-0006
2. The Customer Number for the Fee Addressee is **26809**.
3. Any prior FEE ADDRESSEE for this patent is hereby revoked.

Serial No. 09/023,146

4. It is certified that the person whose signature appears below has the authority to change the FEE ADDRESSEE for this patent.

Respectfully submitted,

A handwritten signature in black ink, appearing to read 'J. Walkowski', with a large, sweeping loop at the end.

Joseph A. Walkowski
Registration No. 28,765
Attorney for Applicant
TRASKBRITT
P.O. Box 2550
Salt Lake City, Utah 84110-2550
Telephone: 801-532-1922

Date: June 25, 2007
JAW/dlm:slm

Document in ProLaw